

Rumour Mill Mulls Next Moto X Phone

Written by Marco Attard
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Rumours emerge on the next Motorola smartphone-- HelloMotoHK leaks images of what appears to be a flatter, metal-clad Moto X, while VentureBeat suggest the phone offers "an ecosystem of modular, swappable backplates."



The HelloMotoHK Google+ page shows a metallic body with a bump housing the camera and a dual-speaker array on the back and a fingerprint reader on the front. As for internal specifications, the grapevine claims the 5.5-inch Android handset carries a Qualcomm Snapdragon 820 CPU, up to 4GB of RAM and 32GB storage.

However the VentureBeat story has the more interesting claims. According to unnamed sources the Moto X comes in two versions (the "Vertex" and "Vector Thin"), each with swappable backplates adding "significant additional functionality" to the phone.

The concept is similar to that previously seen in the LG G5-- users snap modular backplates dubbed "Amps" on the phone via magnets and a 16-pin connector. However the Motorola add-ons are easier to use than the LG version, since the so-called "LG Friends" require the removal of the battery to actually install.

Motorola supposedly has 6 Amps planned for launch, with a simple coloured backplate included with the device. VentureBeat adds Amps available on launch will include stereo speakers, a battery pack, camera grip (complete with flash and optical zoom), pico projector and a wide-angle lens attachment.

When will be able to confirm the existence of this latest Moto X? No official word is available from Motorola or owner Lenovo as yet, but Droid-Life reports the launch takes place on 9 July 2016 at Lenovo Tech Word.

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Go [HelloMotoHK Moto X Images \(Google+\)](#)

Go [Motorola is Preparing 2 Moto X Flagships With a Modular Backplate Design \(VentureBeat\)](#)